TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7W14FU, TC7W14FK

#### Schmitt Inverter

The TC7W14 is high speed  $\rm C^2MOS$  Schmitt Inverter fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the  $C^2MOS$  low power dissipation.

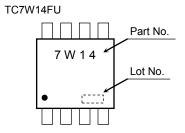
Pin configuration and function are the same as the TC7WU04 but the inputs have 25% VCC hysteresis and with its Schmitt trigger function, the TC7W14 can be used as a line receivers which will receive slow input signals.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

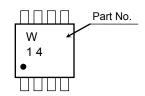
### **Features**

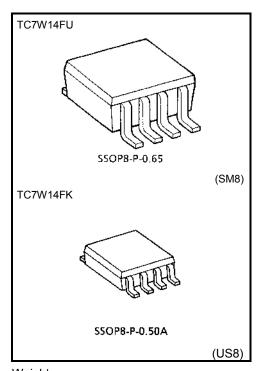
- High speed: t<sub>pd</sub> = 11 ns (typ.) at V<sub>CC</sub> = 5 V
- Low power dissipation:  $I_{CC} = 1\mu A$  (max) at Ta = 25°C
- High noise immunity: V<sub>H</sub> = 1.1 V at V<sub>CC</sub> = 5V
- · Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |I<sub>OH</sub>| = I<sub>OL</sub> = 4mA (min)
- Balanced propagation delays: t<sub>pLH</sub> ≃ t<sub>pHL</sub>
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 6V

### Marking



TC7W14FK





Weight SSOP8-P-0.65: 0.02 g (typ.) SSOP8-P-0.50A: 0.01 g (typ.)

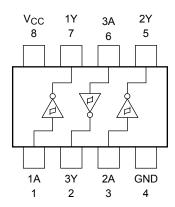
### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC}$ + $0.5$	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	I <sub>OK</sub>	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±25	mA
Power dissipation	PD	300 (SM8)	mW
Fower dissipation	FD	200 (US8)	IIIVV
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C
Lead temperature (10 s)	TL	260	°C

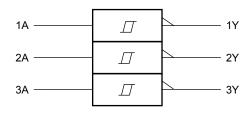
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Pin Configuration (top view)



### **Logic Diagram**



### **Truth Table**

Α	Y
L	Н
Н	L

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C

# **Electrical Characteristics**

### **DC Electrical Characteristics**

Characteristics Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit			
		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	0			
				_		1.0	1.25	1.5	1.0	1.5	-
Threshold voltage	$V_P$		2.3			2.7	3.15	2.3	3.15		
				6.0	3.0	3.5	4.2	3.0	4.2	V	
					2.0	0.3	0.65	0.9	0.3	0.9	V
	Low level	V <sub>N</sub>	_		4.5	1.13	1.6	2.0	1.13	2.0	
					6.0	1.5	2.3	2.6	1.5	2.6	
					2.0	0.3	0.6	1.0	0.3	1.0	
Hysteresis voltage V <sub>H</sub> —	_	4.5	0.6	1.1	1.4	0.6	1.4	V			
						0.8	1.2	1.7	8.0	1.7	
		ligh level V <sub>OH</sub>	$V_{IN} = V_{IL}$	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	1.9	_	
High level Output					4.5	4.4	4.5	_	4.4	_	
	High level				6.0	5.9	6.0	_	5.9	_	
				I <sub>OH</sub> = -4 mA	4.5	4.18	4.31	_	4.13	_	
			I <sub>OH</sub> = -5.2 mA	6.0	5.68	5.80	_	5.63	_	\ /	
voltage  Low level	V <sub>OL</sub> V <sub>IN</sub> = V	I <sub>OL</sub> = 20 μΑ		2.0	_	0	0.1	_	0.1	V	
			4.5	_	0	0.1	_	0.1			
		$V_{IN} = V_{IH}$	ı = V <sub>IH</sub>	6.0	_	0	0.1	_	0.1	1	
			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	_	0.33		
				I <sub>OL</sub> = 5.2 mA	6.0		0.18	0.26	_	0.33	
Input leakage	current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	±0.1	_	±1.0	μА
Quiescent sup	ply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	1.0	_	10.0	μА

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# AC Electrical Characteristics ( $C_L = 15 \text{ pF}, V_{CC} = 5 \text{ V}, Ta = 25^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	-	l lmit		
		rest Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub> t <sub>THL</sub>		_	4	8	ns
Propagation delay time	t <sub>pLH</sub> t <sub>pHL</sub>	_	_	11	21	ns

### AC Electrical Characteristics ( $C_L = 50 \text{ pF}$ , input $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
		100t Containon	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Output transition time		_	2.0		30	75		95	ns
	t <sub>TLH</sub> t <sub>THL</sub>		4.5	_	8	15	_	19	
	THE		6.0	_	7	13	_	16	
Propagation delay time	t <sub>pLH</sub>	_	2.0		42	125		155	ns
			4.5		14	25		31	
			6.0	_	12	21	_	26	
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>		(Note)	_	28	_	_	_	pF

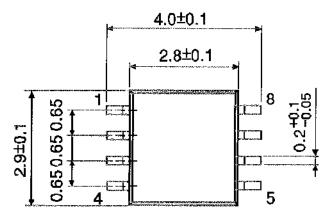
Note: C<sub>PD</sub> is defined as the value of internal equivalent capacitance of IC which is calculated from the operating current consumption without load.

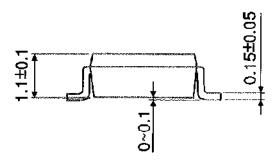
Average operating current can be obtained by the equation hereunder.

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/3 \text{ (per gate)}$ 

# **Package Dimensions**

SSOP8-P-0.65 Unit: mm



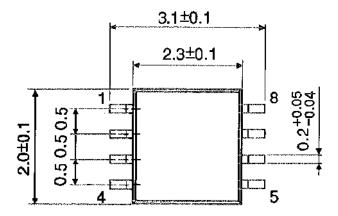


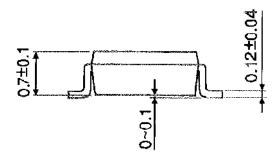
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Weight: 0.02 g (typ.)

# **Package Dimensions**

SSOP8-P-0.50A Unit: mm





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Weight: 0.01 g (typ.)

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